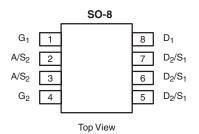




# Dual N-Channel 30-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY						
	V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
Channel-1		$0.0185$ at $V_{GS} = 10 \text{ V}$	6.8	7.8		
Chamilei-1	30	$0.0225$ at $V_{GS} = 4.5 \text{ V}$	6.0	7.0		
Ohamad 0	30	0.0115 at V <sub>GS</sub> = 10 V	11.4	11.6		
Channel-2		0.016 at V <sub>GS</sub> = 4.5 V	9.5	11.0		

SCHOTTKY PRODUCT SUMMARY					
V <sub>DS</sub> (V)	V <sub>SD</sub> (V) Diode Forward Voltage	I <sub>F</sub> (A)			
30	0.50 V at 1.0 A	2.0			

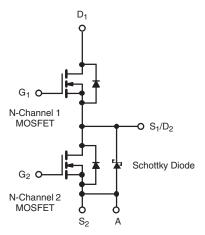


Ordering Information: Si4816BDY-T1-E3 (Lead (Pb)-free) Si4816BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Available
- LITTLE FOOT<sup>®</sup> Plus Power MOSFET
- 100 % R<sub>g</sub> Tested





<b>ABSOLUTE MAXIMUM RATINGS</b> T <sub>A</sub> = 25 °C, unless otherwise noted								
			Channel-1		Channel-2			
Parameter	Symbol	10 s	Steady State	10 s	Steady State	Unit		
Drain-Source Voltage	$V_{DS}$		30	)		.,		
Gate-Source Voltage	$V_{GS}$	20				V		
O	T <sub>A</sub> = 25 °C		6.8	5.8	11.4	8.2		
Continuous Drain Current $(T_J = 150  ^{\circ}\text{C})^a$	T <sub>A</sub> = 70 °C	- I <sub>D</sub>	5.5	4.6	9.0	6.5		
Pulsed Drain Current		I <sub>DM</sub>	30		40		Α	
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	1	0.9	2.2	1.15		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	10		20			
Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>		5		20	mJ	
	T <sub>A</sub> = 25 °C	В	1.4	1.0	2.4	1.25	w	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C	- P <sub>D</sub>	0.9	0.64	1.5	0.8	VV	
Operating Junction and Storage Temperatu	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150				°C		

THERMAL RESISTANCE RATINGS									
		Chan	nel-1	Chan	nel-2	Scho	ottky		
Parameter	Symbol	Тур.	Max.	Тур.	Max.	Тур.	Max.	Unit	
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 10 s	R <sub>thJA</sub>	72	90	43	53	48	60	
Maximum Junction-to-Ambient	Steady State	itnJA	100	125	82	100	80	100	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	51	63	25	30	28	35	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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MOSFET SPECIFICATIONS Parameter	Symbol	Test Conditions	Min.	Typ.a	Max.	Unit		
Static	Symbol	lest Conditions		win.	тур.	wax.	Unit	
Static			Ch-1	1.0		3.0		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	Ch-2	1.0		3.0	V	
Oata Badal aslassa	1	V 0.V.V 20.V	Ch-1			100	^	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}$	Ch-2			100	nA	
		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	Ch-1			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	VDS = 00 V, VGS = 0 V	Ch-2			100	μΑ	
	D33	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 85 °C	Ch-1			15	μ	
			Ch-2			2000		
On-State Drain Current <sup>b</sup>	$I_{D(on)}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	Ch-1	20			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.8 A	Ch-2 Ch-1	30	0.0155	0.0185		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 11.4 A	Ch-2		0.0155			
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_D = 11.4 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 6.0 \text{ A}$				0.0115	Ω	
			Ch-1		0.0185	0.0225		
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 9.5 A	Ch-2		0.013	0.016		
Forward Transconductance <sup>b</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 6.8 A	Ch-1		30		S	
		V <sub>DS</sub> = 15 V, I <sub>D</sub> = 11.4 A	Ch-2		31			
Diode Forward Voltage <sup>b</sup>	$V_{SD}$	I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V	Ch-1		0.73	1.1	V	
		I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V	Ch-2		0.47	0.5		
Dynamic <sup>a</sup>						1		
Total Gate Charge	$Q_g$	Channel-1	Ch-1		7.8	10		
		$V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 6.8 \text{ A}$	Ch-2 Ch-1		11.6 2.9	18		
Gate-Source Charge	$Q_gs$		Ch-2		4.8		nC	
		Channel-2 $V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = -11.4 \text{ A}$	Ch-1		2.3			
Gate-Drain Charge	$Q_{gd}$	$v_{DS} = 13 \text{ v}, v_{GS} = 3 \text{ v}, v_{D} = -11.4 \text{ A}$	Ch-2		3.7			
Outo Projetova			Ch-1	1.5	3.0	4.5		
Gate Resistance	$R_g$		Ch-2	0.9	1.8	2.7	Ω	
Turn-On Delay Time	t <sub>=(</sub> )	<u> </u>	Ch-1		11	17		
Turn-On Delay Time	t <sub>d(on)</sub>	Channel-1	Ch-2		13	20		
Rise Time		$V_{DD} = 15 \text{ V}, R_L = 15 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 6 \Omega$	Ch-1		9	15		
-	•	D 1., I GEN 12 1, 1.9	Ch-2		9	15		
Turn-Off Delay Time	t <sub>d(off)</sub>	Channel-2	Ch-1		24	40	ns	
	t <sub>f</sub>	$V_{DD} = 15 \text{ V}, R_{L} = 15 \Omega$	Ch-2 Ch-1		31 9	50 15		
Fall Time		$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$	Ch-2		11	17		
		I <sub>F</sub> = 1.3 A, dI/dt = 100 A/μs	Ch-1		20	35		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	$I_F = 2.2 \text{ A}, \text{ dI/dt} = 100 \mu\text{A/}\mu\text{s}$	Ch-2		25	40	1	
			O11-2		23	70		

a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

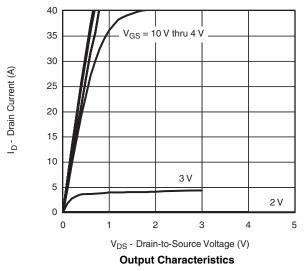


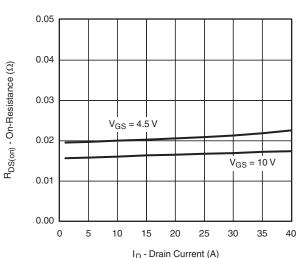


<b>SCHOTTKY SPECIFICATIONS</b> $T_J = 25$ °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Forward Voltage Drop	V <sub>F</sub>	I <sub>F</sub> = 1.0 A		0.47	0.50	V	
Forward voitage Drop		I <sub>F</sub> = 1.0 A, T <sub>J</sub> = 125 °C		0.36	0.42		
		V <sub>R</sub> = 30 V		0.004	0.100		
Maximum Reverse Leakage Current	I <sub>rm</sub>	V <sub>R</sub> = 30 V, T <sub>J</sub> = 100 °C		0.7	10	mA	
		V <sub>R</sub> = - 30 V, T <sub>J</sub> = 125 °C		3.0	20		
Junction Capacitance	C <sub>T</sub>	V <sub>R</sub> = 10 V		50		pF	

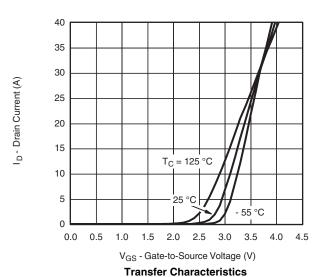
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

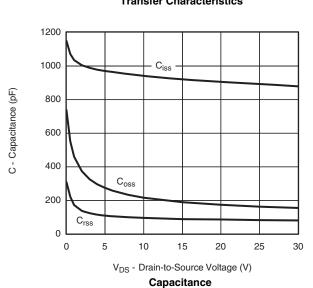
#### CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





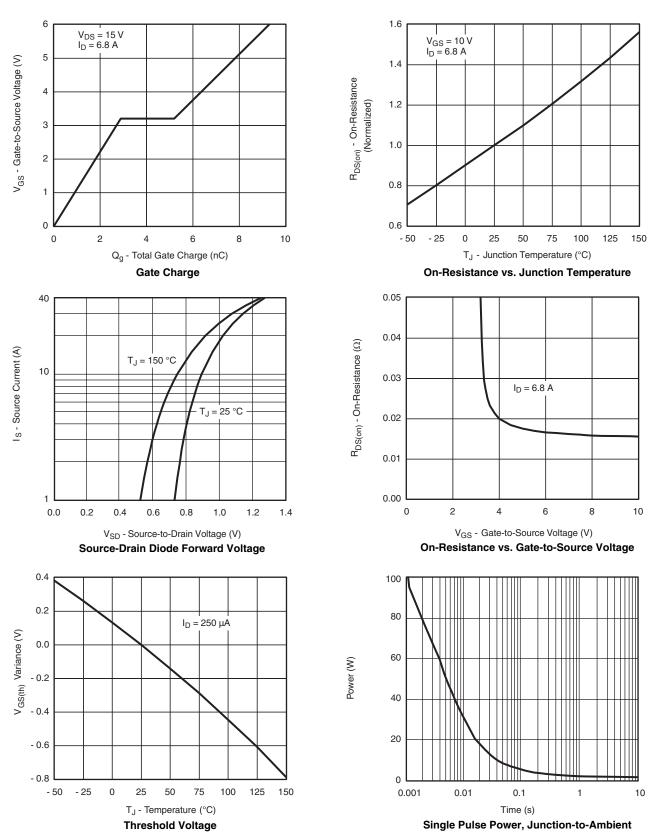
On-Resistance vs. Drain Current





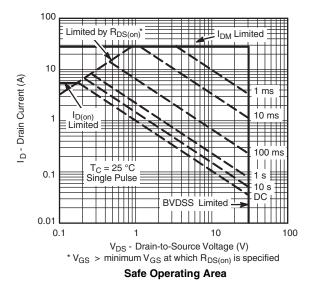


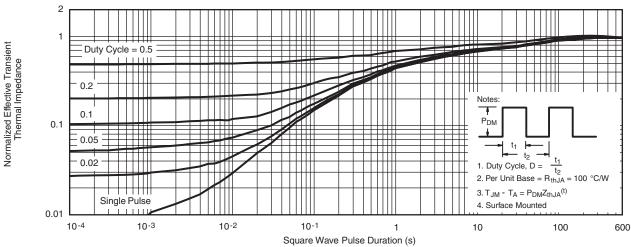
#### CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



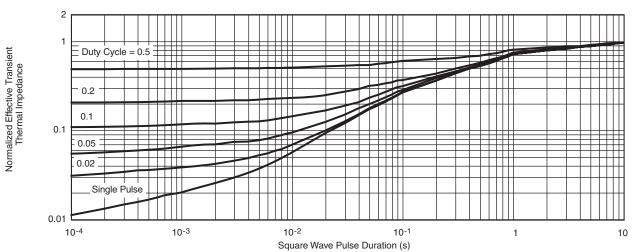


#### CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





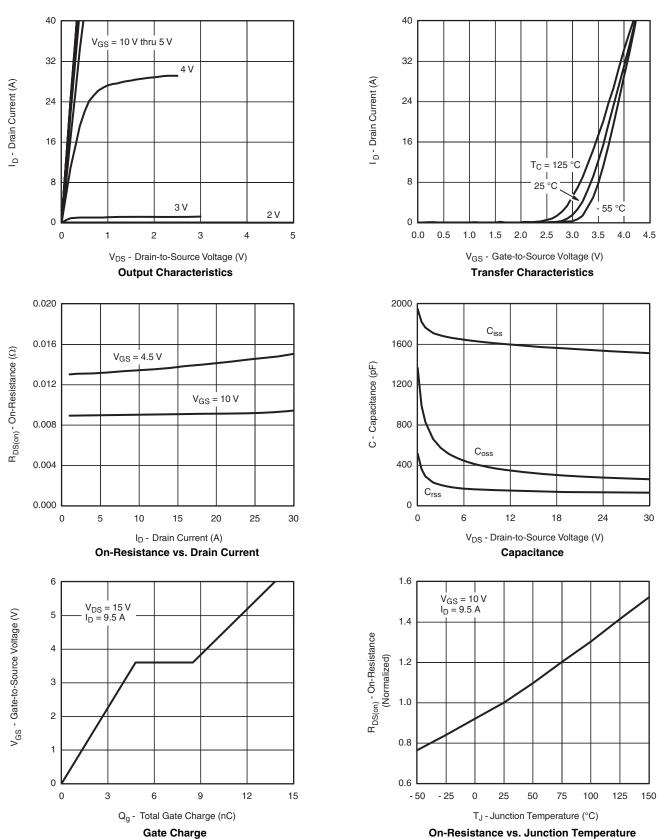
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

# VISHAY.

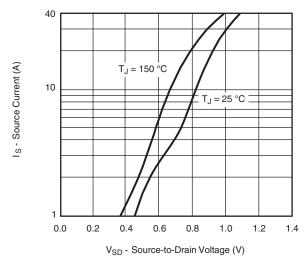
#### CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



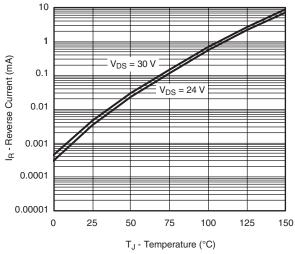




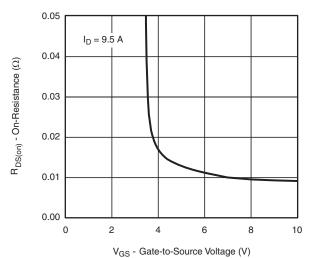
#### CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



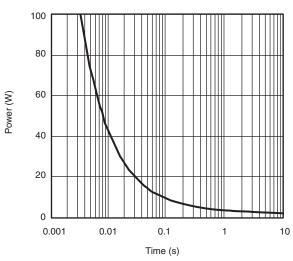
#### Source-Drain Diode Forward Voltage



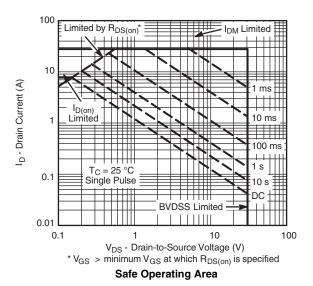
**Reverse Current vs. Junction Temperature** 



On-Resistance vs. Gate-to-Source Voltage



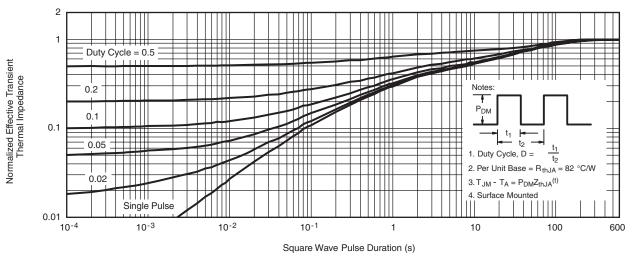
Single Pulse Power, Junction-to-Ambient



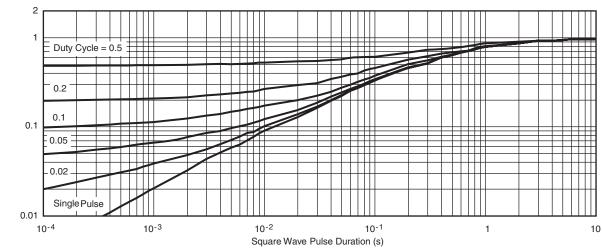
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#### CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

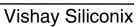


#### Normalized Thermal Transient Impedance, Junction-to-Ambient



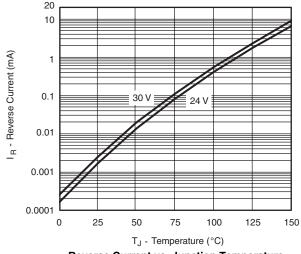
Normalized Thermal Transient Impedance, Junction-to-Foot

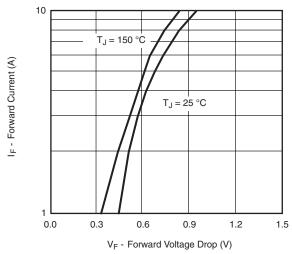
Normalized Effective Transient Thermal Impedance





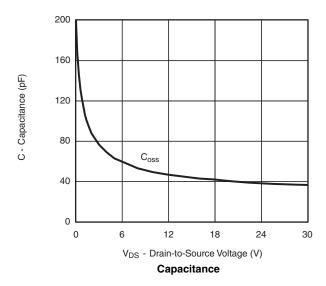
### SCHOTTKY TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





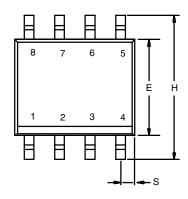
**Reverse Current vs. Junction Temperature** 

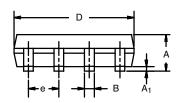


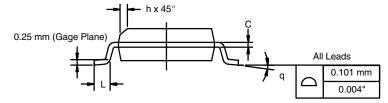


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**SOIC (NARROW): 8-LEAD** JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	) BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOT

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